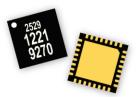
Applications

- Point to Point Radio / VSAT
- Millimeter-wave Communications
- Test Equipment





32-pin 5x5mm package

Product Features

- Frequency range: 12.5 13.5 GHz
- Tune Voltage: 1 13 V
- Output power: 7 dBm Typical
- Phase Noise: -110 dBc/Hz@100 KHz Typical -133 dBc/Hz@1 MHz Typical
- RFout/2 Frequency Range: 6.25 6.75 GHz
- RFout/2 Output Power: 6 dBm Typical
- Bias: Vcc = 5V, Icc = 165 mA Typical
- Technology: TriQuint HBT
- Dimension: 5 x 5 x 0.85 mm SLP

General Description

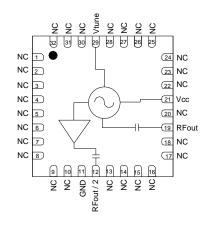
The TriQuint TGV2529-SM is a monolithic voltage controlled oscillator (VCO) designed to operate at frequencies that target the Point to Point, VSAT, and millimeter-wave communication markets.

The TGV2529-SM is manufactured on TriQuint's GaAs InGaP production process and typically provides 7 dBm output power at 13GHz with a -110dBc/Hz phase noise at 100 KHz offset. A divide-by-2 output is provided for the PLL function.

Lead-free and RoHS compliant.

Evaluation Boards are available upon request.

Functional Block Diagram



Pin Configuration

Pin #	Function Label
11	GND
12	RFout/2
19	RFout
21	Vcc
29	Vtune
1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 13, 14, 15, 16, 17, 18, 20, 22, 23, 24, 25, 26, 27, 28, 30, 31, 32	NC

Ordering Information

Part No.	ECCN	Description		
TGV2529-SM	EAR99	12.5 – 13.5 GHz VCO with Divide by 2		
Standard T/R size = 500 pieces on a 7.0" reel.				



Specifications

Absolute Maximum Ratings

Parameter	Rating
Supply Voltage, Vcc	+5.5V
Tuning Voltage, Vtune	+14V
Power Dissipation, Pdiss	1.1W
Junction Temperature	200°C
Storage Temperature	-65 to 125°C

Operation of this device outside the parameter ranges given above may cause permanent damage.

Recommended Operating Conditions

Parameter	Min	Тур	Max	Units
Operating Temp. Range	-40	+25	+85	°C
Supply Voltage, Vcc	4.8	5.0	5.2	V
Supply Current, Icc		165		mA
Tuning Voltage, Vtune	1		12	V

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

Test conditions unless otherwise noted: 25 °C, Vcc = 5 V, Icc = 165mA

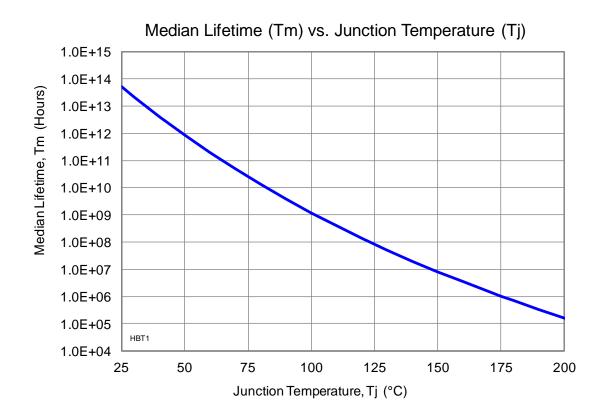
Parameter	Conditions	Min	Тур	Max	Units
Operational Frequency		12.5		13.5	GHz
RFout/2 Output Frequency		6.25		6.75	GHz
Supply Voltage, Vcc		4.8	5	5.2	V
Supply Current, Icc		140	165	190	mA
Output Power		4	7	12	dBm
RFout/2 Output Power		2	6	10	dBm
Tuning Sensitivity	Vtune = 5V		175		MHz/V
Output Return Loss			7		dB
RFout/2 Output Return Loss			5		dB
Tuning Voltage		1		13	V
Pushing	Vtune = 5V		10		MHz/V
Pulling	VSWR 2:1		5		MHz (p-p)
Harmonics Freq/2 3*Freq/2 2*Freq			21 30 49		dBc
Phase Noise @ 10KHz Offset	Vtune = 5V		-80		dBc/Hz
Phase Noise @ 100KHz Offset	Vtune = 5V		-110		dBc/Hz
Phase Noise @ 1MHz Offset	Vtune = 5V		-133		dBc/Hz
Frequency Drift Rate			1.1		MHz/°C
Vtune Leakage	Vtune = 12V		5		μΑ



Specifications

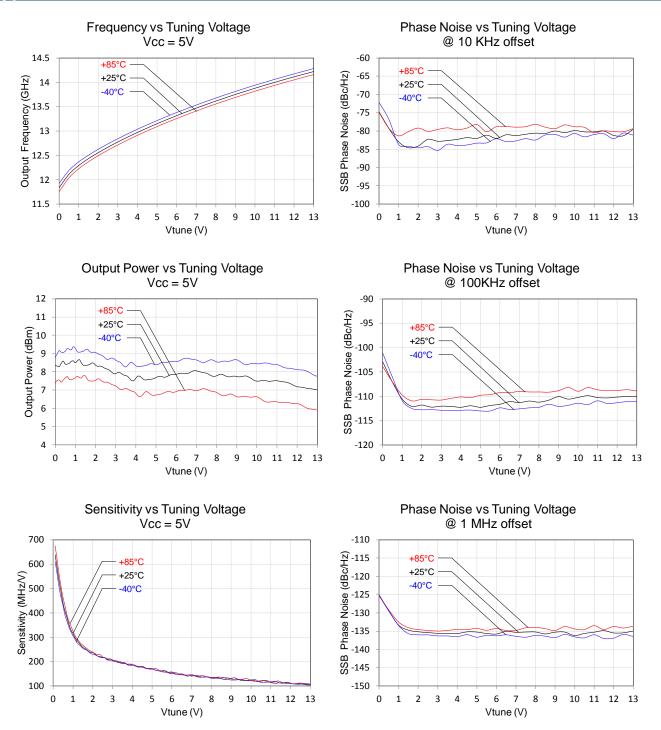
Thermal and Reliability Information

Parameter	Condition	Rating
Thermal Resistance, θ_{JC} , measured to back of package	Tbase = 85 °C	$\theta_{\rm JC} = 48 \ ^{\circ}{\rm C/W}$
Junction Temperature (Tj), and Median Lifetime (Tm)	Tbase = 85 °C Vd = 5V Id = 165mA	Tch = 125 °C Tm = 8.4 E+7 Hours



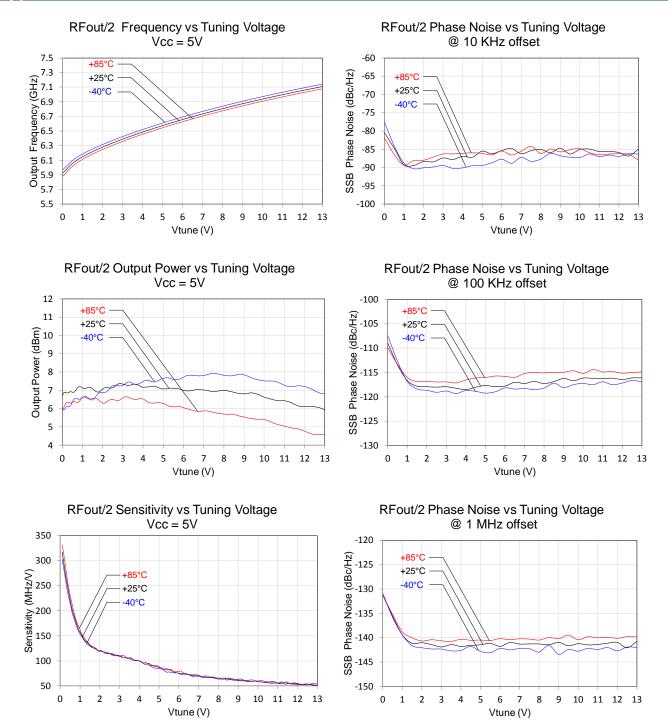


Typical Performance





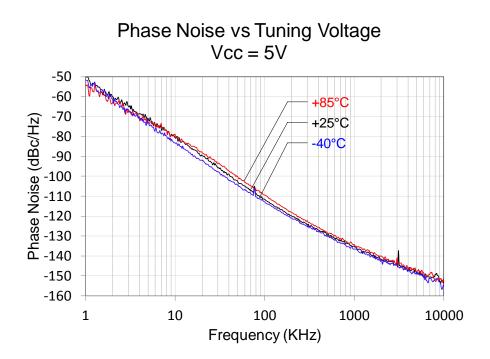
Typical Performance

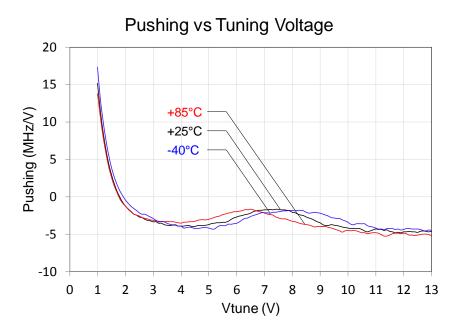


TGV2529-SM 12.5 – 13.5 GHz VCO with Divide by 2



Typical Performance



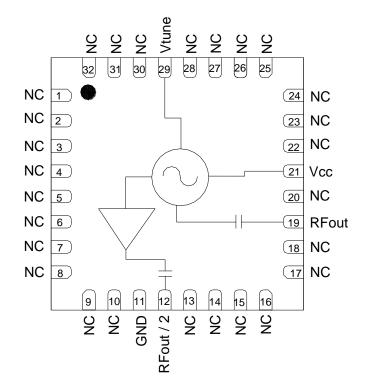


TGV2529-SM

12.5 – 13.5 GHz VCO with Divide by 2



Pin Description



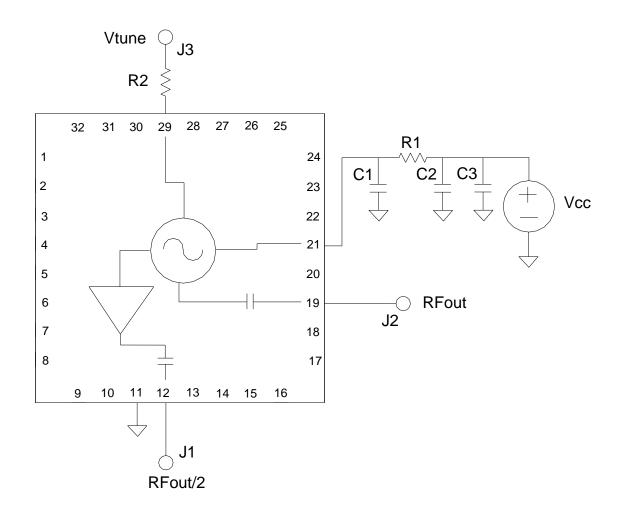
Pin	Symbol	Description
1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 13, 14, 15, 16, 17, 18, 20, 22, 23, 24, 25, 26, 27, 28, 30, 31, 32	NC	No internal connection.
11	GND	Backside Paddle. Multiple vias should be employed to minimize inductance and thermal resistance
12	RFout/2	Frequency/2 Output match to 50 ohms, AC coupled
19	RFout	Output, matched to 50 ohms, AC coupled
21	Vcc	Supply voltage. Bias network is required; see Application Circuit on page 8 as an example.
29	Vtune	VCO tuning voltage.

TGV2529-SM

12.5 – 13.5 GHz VCO with Divide by 2



Application Circuit



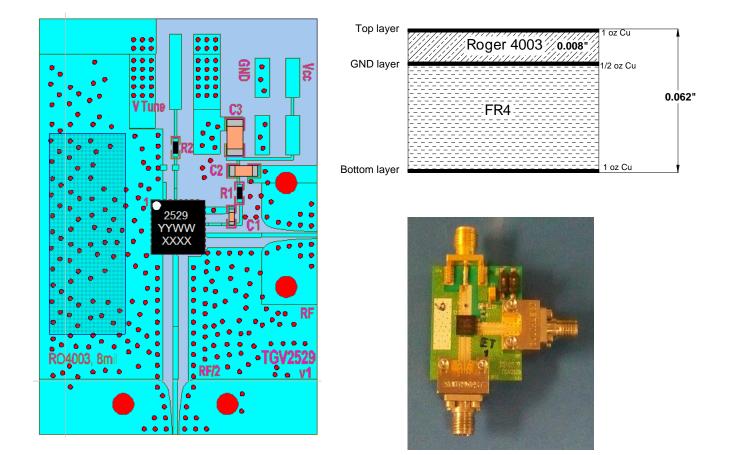


Application Circuit

PC Board Layout

Top RF layer is 0.008" thick Roger RO4003, $\varepsilon_r = 3.38$. Microstrip 50 Ω line detail: width =0.0175". For further technical information, refer to the <u>TGV2529-SM</u> Product Information page.

The pad pattern shown has been developed and tested for optimized assembly at Triquint Semiconductor. The PCB land pattern has been developed to accommodate lead and package tolerance. Since surface mount processes vary from company to company, careful process development is recommended.



Bill of Material

Ref Des	Value	Description	Manufacturer	Part Number
C1	100 pF	Ceramic Cap, 0402	various	
C2	1 µF	Ceramic Cap, 0603	various	
C3	10 µF	Tantalum Cap, 0805/1206	various	
R1, R2	0 ohm	Chip Res, 0402	various	

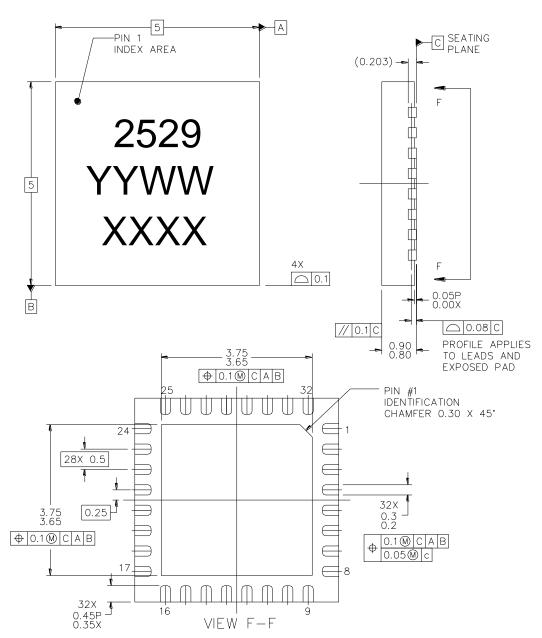
Data Sheet: Rev B 11/10/15 © 2012 TriQuint Semiconductor, Inc.



Mechanical Information

Package Marking and Dimensions

All dimensions are in millimeters.



This package is lead-free/RoHS-compliant. The package base is copper alloy and the plating material on the leads is 100% matte Sn annealed. It is compatible with both lead-free (maximum 260 °C reflow temperature) and tin-lead (maximum 245 °C reflow temperature) soldering processes.

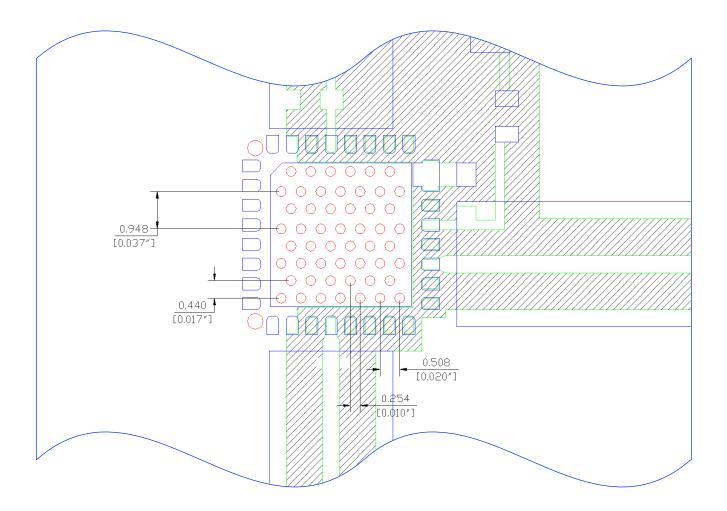
The TGV2529-SM will be marked with the "2529" designator and a lot code marked below the part designator. The "YY" represents the last two digits of the year the part was manufactured, the "WW" is the work week, and the "XXXX" is last 4 digits of lot number.



Mechanical Information

PCB Mounting Pattern

All dimensions are in millimeters [inches].



Notes:

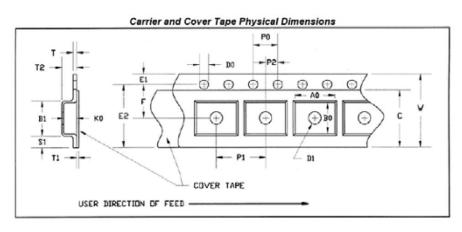
- 1. The pad pattern shown has been developed and tested for optimized assembly at TriQuint Semiconductor. The PCB land pattern has been developed to accommodate lead and package tolerances. Since surface mount processes vary from company to company, careful process development is recommended.
- 2. Ground / thermal vias are critical for the proper performance of this device. Vias have a final plated thru diameter of .25 mm (.010").



Tape and Reel Information

Tape and reel specifications for this part are also available on the TriQuint website in the "Application Notes" section.

Standard T/R size = 500 pieces on a 7.0" reel.



CARRIER AND COVER TAPE DIMENSIONS

Part	Feature	Symbol	Size (in)	Size (mm)
Cavity	Length	A0	0.207	5.25
	Width	B0	0.207	5.25
	Depth	K0	0.043	1.1
	Pitch	P1	0.315	8.00
Distance Between Centerline	Cavity to Perforation Length Direction	P2	0.079	2.00
	Cavity to Perforation Width Direction	F	0.217	5.50
Cover Tape	Width	С	0.374	9.50
Carrier Tape	Width	W	0.472	12.00



Product Compliance Information

ESD Information



ESD Rating:Class 0Value:Passes ≥ 200V minTest:Human Body Model (HBM)Standard:JEDEC Standard JESD22-A114

MSL Rating

Moisture Sensitivity Level (MSL) 3 at 260°C convection reflow per JEDEC standard IPC/JEDEC J-STD-020.

Solderability

Compatible with both lead-free (260 °C max. reflow temp.) and tin/lead (245 °C max. reflow temp.) soldering processes.

Package lead plating: matte Sn annealed

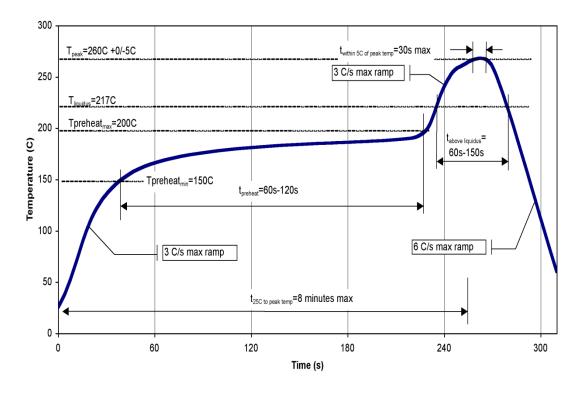
RoHS Compliance

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄0₂) Free
- PFOS Free
- SVHC Free

Recommended Soldering Temperature Profile



Data Sheet: Rev B 11/10/15 © 2012 TriQuint Semiconductor, Inc.



Contact Information

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